1-0011

INFORMATION DISCLOSURE STATEMENT

Atty. Docket No.: 150.00720102 **Serial No.:** 09/651,217

Applicant(s): Cobbley et al.

Filing Date: August 30, 2000 Group: 2811 2834

DEC 0 4 2000

U.S. PATENT DOCUMENTS

U.S. PATENT DOCUMENTS						
Examiner Initial	Document Number	Date	Name	Class	SubClass	Filing Date If Appropriate
J. Q. G.	Re 32,889	3/14/89	Litke			
5.8.6.	3,142,698	7/28/64	Halpern et al.			
5.B.G.	3,825,580	7/23/74	Kato et al.			
S. B.G.	3,832,334	8/27/74	O'Sullivan et al.	<u> </u>		
S.B.G.	3,984,749	10/5/76	Müller			
5.6.6.	4,139,693	2/13/79	Schoenberg	_		
5.8.8.	4,167,546	9/11/79	Korshak, et al.			
S.B.6.	4,295,909	10/20/81	Baccei		_	
S.B.G.	4,309,526	1/5/82	Baccei			
5.B.G.	4,862,245	8/29/89	Pashby et al.			
5.0.6.	5,079,098	1/7/92	Liu			
1 B. G.	5,286,679	2/15/94	Farnworth et al.			
S.B.G.	5,288,794	2/22/94	Attarwala		. –	
s.B.6.	5,328,944	7/12/94	Attarwala et al.			
S. B. G.	5,386,047	1/31/95	Nakos et al.			
J.B.G.	5,424,343	6/13/95	Attarwala	-		
S. B. €	5,536,799	7/16/96	Takahashi et al.		_	
J.B.G.	5,589,554	12/31/96	Hiraoka			
S.B.G.	5,001,542	3/91	Tsukagoshi et al.	357	68	
J.B.G.	4,021,767	5/77	Nonaka et al.	338	32H	
S.B.G.	4,815,208	3/89	Raschke	29	832	
S B. G.	5,252,855	10/93	Ogawa et al.	257	676	
S.B. F.	5,945,733	8/99	Corbett et al.	257	676	

FOREIGN PATENT DOCUMENTS

	Document Number	Date	Country	Class	SubClass	Trans	lation
						Yes	No
	NONE						

EXAMINER 3	Date Considered / \$\frac{24}{3} \rightarrow 1
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^{*}Examiner: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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INFORMATION DISCLOSURE: STATEMENT

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Atty. Docket No.: 150.00720102 **Serial No.:** 09/651,217

Applicant(s): Cobbley et al.

Filing Date: August 30, 2000

Group: 281ト スピスリ

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S.B.G. S.D.G.	Chorbadjiev, K. et al., "The effect of fillers upon the properties of electroconductive cyanoacrylate adhesives," <u>Int. J. Adhesion and Adhesives</u> , <u>8</u> , 143-146 (July 1988).
5,0.6.	Melody, D., "Advances in Room Temperature Curing Adhesives and Sealants - A Review," <u>British Polymer Journal</u> , <u>21</u> , 175-179 (1989).
SBG.	LOCTITE®, product description sheet, Rocky Hill, CT, 4 pgs. (December 1996).
S B.F.	Loctite Corporation, "VARIDOT™ Surface Mount Adhesive Printing Process," advertising brochure, Rocky Hill, CT.
5.B.G.	Millet, G., "Properties of Cyanoacrylates - An Overview," <u>Adhesives Age</u> , 27-32 (October 1981).
5 B.G.	Microelectronics Packaging Handbook, 554-557 (1989).
5 B. G.	Pepper, D. C., "Kinetics and Mechanisms of Zwitterionic Polymerizations of Alkyl Cyanoacrylates, <u>Polymer Journal</u> , <u>12</u> , 629-637 (1980).
5 B.G.	VanZant, P., Microchip Fabrication, Second Edition, 485-487 (1990).
\$B.G. 5.B.G.	Vijayalakshmi, V. et al., "Synthesis of 3-Substituted-2-cyanoacrylates: Their Evaluation as Cross-linkers in Cyanoacrylate Adhesive Compositions," <u>Journal of Applied Polymer Science</u> , <u>49</u> , 1387-1394 (1993).
5.0.6.	Palmer, B. J. et al., "A New Photoinitiator for Anionic Polymerization," Macromolecules, 1328-1329 (1995).
5.0.6.	Negulescu, I. I. et al., "Thermal Behavior of Poly (α-Cyanoacrylate)," <u>J. Macromol. Sci-Chem.</u> , <u>A24</u> , 75-83 (1987).
5_8_6.	O'Connor, J. T. et al., "Recent Breakthroughs in Thermal Resistant Cyanoacrylate Instant Adhesives," <u>Society of Manufacturing Engineers</u> , 303-303/22 (1993).
5.B.G.	Drain, K. F., et al., "The effect of moisture on the strength of polycarbonate-cyanoacrylate adhesive bonds," <u>Int. J. Adhesion and Adhesives</u> , <u>5</u> , 133-136 (July 1985).
5.8.6	Rooney, J. M., "Thermal Degradation of Methyl and Ethyl Cyanocrylate Oligomers," The British Polymer Journal, 160-163 (December 1981).

EXAMINER N	Date Considered
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 Atty. Docket No.: 150.00720102
 Serial No.: 09/651,217

 Applicant(s): Cobbley et al.

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Filing Date: August 30, 2000 Group: 2811 2829

5.B.G.	Lee, J., "Synthesis and Ring-Opening Polymerization of 3-Methoxy-4-cyano-2, 9-dioxabicyclo[4.3.0]non-3-ene:Preparation of Alternating Head-to-Head Copolymer of Methyl α-cyanocrylate and 2, 3-Dihydrofuran," Journal of Polymer Science: Part C: Polymer Letters, 27, 85-91 (1989).
5.8.6	Cooke, B. D. et al., "Cyanoacrylates and their acid values," Int. J. Adhesion and Adhesives, 13, 73-76 (April 1993).
5.8.6.	Ito, H., "Thermal Deesterification and Decarboxylation of Alternating Copolymers of Styrene with β-Substituted <i>t</i> -Butyl α-Cyanoacrylates," <u>Journal of Polymer Science</u> : Part A: Polymer Chemistry, <u>27</u> , 2871-2881 (1989).
S.B.G.	Mikuni et al., "Morphological Study of Cyanoacrylate Adhesive Modified by Poly(butadiene-co-acrylonitrile)," <u>Polym. Networks & Blends</u> , <u>5(3)</u> , 159-162 (1995).
S. B.F.	Stein, "Thermal Behavior of Various Poly(2-Cyanoacrylate)S," <u>Journal of Applied</u> Poly Science, 48, 441-447 (1991).

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Det a to	10/30/01

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